

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
FEI HU	05/04/2017
YI LI	05/04/2017
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	APPOTRONICS CHINA CORPORATION
<b>Street Address:</b>	4TH FLOOR, SZICC, NO.1089, CHAGUANG ROAD, XILI TOWN, NANSHAN DISTRICT
<b>City:</b>	SHENZHEN
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	518055
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14432018
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<b>ATTORNEY DOCKET NUMBER:</b>	79592.0054
<b>NAME OF SUBMITTER:</b>	YING CHEN
<b>SIGNATURE:</b>	/Ying Chen/
<b>DATE SIGNED:</b>	05/05/2017
<b>Total Attachments: 1</b>	
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ASSIGNMENT

(1-6) Name(s) of Inventor(s)

(1) Fei HU (2) Yi LI (3) Liangliang CAO (4) Yi YANG

In consideration of the good and valuable considerations paid to each of the undersigned, the undersigned agree(s) to assign, and hereby do(es) assign, transfer and set over to

(7) Name of Assignee

(7) Appotronics China Corporation

(8) State of Incorporation of Assignee

(8) China

(9) Address of Assignee

(9) 4th Floor, SZICC, NO.1089, Chaguang Road, Xili Town, Nanshan District, Shenzhen, 518055, P. R. China (hereinafter designated as the Assignee)

the entire worldwide right, title and interest in the invention known as

(10) Identification of Invention, such as Title, Case Number or Foreign Application Number

(10) Title: METHOD AND APPO

U.S. Patent Application No. 14/432,018, filed March 27, 2015 and all patents and patent applications in the United States or foreign countries corresponding thereto or based thereon.

1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

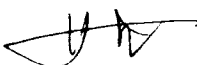
3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

6) The undersigned hereby appoint(s) the persons associated with Customer Number 53720 the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Signature of Inventor 1                     *Fei Hu*                     Date: May 4, 2017

Signature of Inventor 2                                          Date: May 4, 2017

Signature of Inventor 3 \_\_\_\_\_ Date: \_\_\_\_\_

Signature of Inventor 4 \_\_\_\_\_ Date: \_\_\_\_\_